# imall

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					October 1997		
	6302P	_					
Digi	tal FET, Dual P-Chanr	nel					
Gener	al Description		Features				
These Dual P-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors in load switchimg applications. Since bias resistors are not required this one P-Channel FET can replace several digital transistors with different bias resistors like the IMBxA series.			<ul> <li>-25 V, -0.12 A continuous, -0.5 A Peak. R<sub>DS(ON)</sub> = 13 Ω @ V<sub>GS</sub>= -2.7 V R<sub>DS(ON)</sub> = 10 Ω @ V<sub>GS</sub> = -4.5 V.     </li> <li>Very low level gate drive requirements allowing direct operation in 3V circuits. V<sub>GS(th)</sub> &lt; 1.5V.     </li> <li>Gate-Source Zener for ESD ruggedness. &gt;6kV Human Body Model     </li> <li>Replace multiple PNP digital transistors (IMHxA series) v one DMOS FET.     </li> </ul>				
		4004					
			нннн		0000000		
	S1				3		
	D1 302 SuperSOT™-6 <sup>pin 1</sup> G1	G2 S2			2		
	D1 302	S2	ed		2		
ymbol	D1 SuperSOT TM-6 Plm 1 G1 ute Maximum Ratings $T_A =$	S2	ed		2		
<b>ymbol</b>	$D1 \xrightarrow{392}_{pin1} G1$ SuperSOT <sup>TM</sup> -6 <sup>pin1</sup> G1 Ute Maximum Ratings T <sub>A</sub> = Parameter	S2	ed	5 6 FDC6302P	2		
ymbol DSS GSS	$D1 \qquad \qquad 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\ 3 \\$	S2	ed	5 6 FDC6302P -25	2		
ymbol DSS GSS	D1 SuperSOT TM-6 $pin 1$ G1 Ute Maximum Ratings $T_A =$ Parameter Drain-Source Voltage Gate-Source Voltage Drain Current - Contin	S2	od	5 6 FDC6302P -25 -8 -0.12	2 1 1 V V V		
ymbol DSS GSS D	$\begin{array}{c} D1 \\ SuperSOT^{TM}-6 \end{array} \begin{array}{c} pin 1 \\ mathbf{T} \\ mathbf{S} \\ mathbf{T} \\$	S2 25°C unless other wise note uous (Note 1a) (Note 1b)	ed	5 6 6 -25 -8 -0.12 -0.5 0.9	2 1 V V V A		
ymbol DSS GSS	D1 $333$ SuperSOT TM-6 $pin 1$ G1         ute Maximum Ratings $T_a =$ Parameter       Drain-Source Voltage         Gate-Source Voltage       Contin         Drain Current       - Contin         - Pulsec       Maximum Power Dissipation	S2	ed	5 6 -25 -8 -0.12 -0.5 0.9 0.7	2 1 V V V A W		
ymbol DSS GSS D D J,T <sub>STG</sub> SD	D1 $p_{in1}$ G1         SuperSOT TM-6 $p_{in1}$ G1         ute Maximum Ratings $T_a =$ Parameter       Drain-Source Voltage         Gate-Source Voltage       Drain Current       - Contin         Drain Current       - Contin         Pulsec       Maximum Power Dissipation         Operating and Storage Temperature         Electrostatic Discharge Rating MI	S2	ed	5 6 6 -25 -8 -0.12 -0.5 0.9 0.7 -55 to 150	2 1 V V V A W C		
ymbol pss sss p ,T <sub>stg</sub> SD	D1 $pin1$ G1         SuperSOT TM-6 $pin1$ G1         Ute Maximum Ratings $T_A =$ Parameter       Drain-Source Voltage         Gate-Source Voltage       Gate-Source Voltage         Drain Current       - Contin         - Pulsec       Maximum Power Dissipation         Operating and Storage Temperature       Electrostatic Discharge Rating MII         Human Body Model (100pf / 1500)       Human Body Model (100pf / 1500)	S2 25°C unless other wise note uous (Note 1a) (Note 1b) re Range STD-883D Ohm)	ed	5 6 6 -25 -8 -0.12 -0.5 0.9 0.7 -55 to 150	2 1 V V V A W C		

(Note 1)

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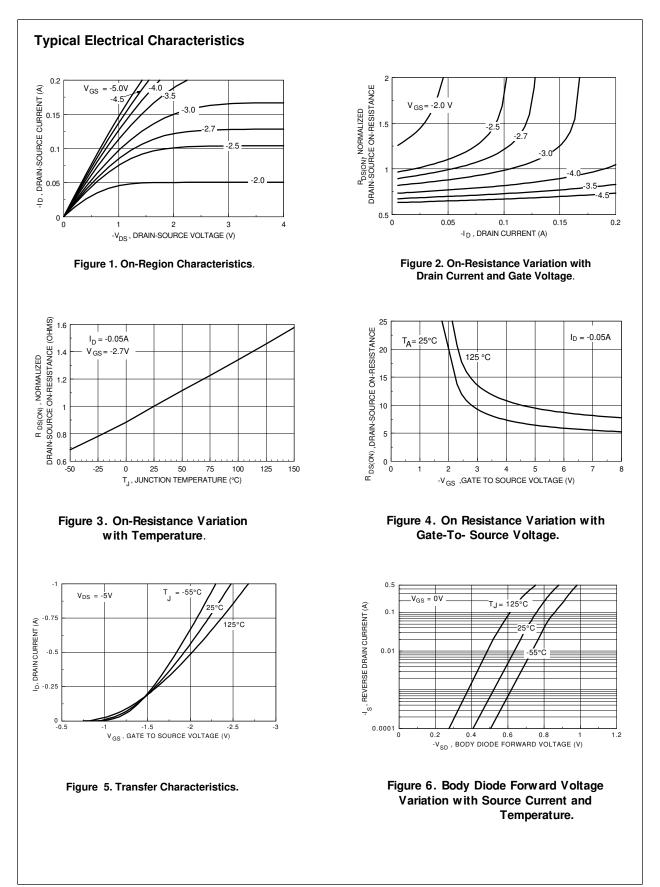
Thermal Resistance, Junction-to-Case

FDC6302P Rev.C

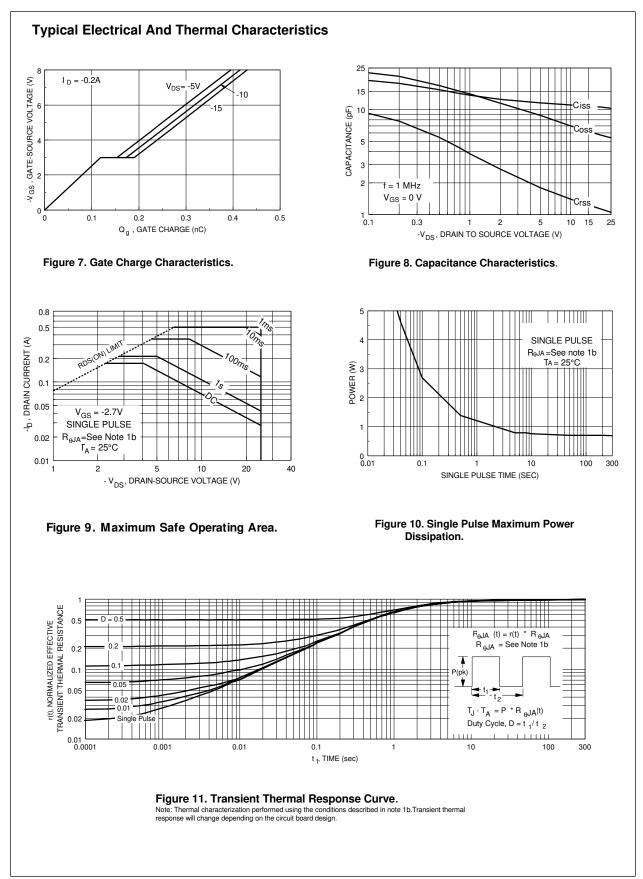
°C/W

60

	Parameter	Conditions	Min	Тур	Max	Units
OFF CHARA	CTERISTICS					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-25			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = -250 $\mu$ A, Referenced to 25 °C		-20		mV /° C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -20 V, V_{GS} = 0 V$			-1	μA
		$T_{J} = 55^{\circ}C$			-10	μA
GSS	Gate - Body Leakage Current	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
ON CHARAC	TERISTICS (Note 2)					
$\Delta V_{GS(th)} / \Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	$I_{_D}\text{=}$ -250 $\mu\text{A},$ Referenced to $~25^{\circ}\text{C}$		1.9		mV /° C
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu {\rm A}$	-0.65	-1	-1.5	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -2.7 \text{ V}, \ I_{D} = -0.05 \text{ A}$		10.6	13	Ω
		$V_{GS} = -4.5 \text{ V}, \ I_{D} = -0.2 \text{ A}$		7.9	10	
		T <sub>J</sub> =125°C		12	18	
D(ON)	On-State Drain Current	$V_{GS} = -2.7 V, V_{DS} = -5 V$	-0.05			Α
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 V, I_{D} = -0.2 A$		0.135		S
DYNAMIC CH	HARACTERISTICS		T	1		
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		11		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		7		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			1.4		pF
	CHARACTERISTICS (Note 2)		r			1
D(on)	Turn - On Delay Time	$V_{DD} = -6 \text{ V}, \text{ I}_{D} = -0.2 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$		5	12	ns
r	Turn - On Rise Time	$v_{GS} = -4.5 v, \ n_{GEN} = 50.52$		8	16	ns
D(off)	Turn - Off Delay Time			9	18	ns
f f	Turn - Off Fall Time			5	10	ns
Q <sup>ª</sup>	Total Gate Charge	$V_{DS} = -5 V, I_{D} = -0.2 A,$ $V_{GS} = -4.5 V$		0.22	0.31	nC
Q <sub>gs</sub>	Gate-Source Charge			0.12		nC
	Gate-Drain Charge RCE DIODE CHARACTERISTICS AND MAXIM			0.05		nC
1	Maximum Continuous Drain-Source Diode Forwa				-0.7	A
s V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -0.7 \text{ A} \text{ (Note 2)}$		-1	-0.7	V
V <sub>SD</sub> Notes:	Brain Gource Block Forward Vollage	$v_{GS} = 0 v, r_{S} = 0.7 A (noie 2)$			1.0	v
design while R <sub>e</sub>	of the junction-to-case and case-to-ambient thermal resistance where $c_{n}$ is determined by the user's board design. 40°C/W on a 0.125 in <sup>2</sup> pad of $0$ b. 180°C/W of 20z copper. See Width $\leq$ 300µs, Duty Cycle $\leq$ 2.0%.	on a 0.005 in <sup>2</sup> of pad		ne uran pins	. n <sub>euc</sub> is gua	aneed by



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